

PATENT ASSIGNMENT

Electronic Version v08
 Stylesheet Version v02

SUBMISSION TYPE:		NEW ASSIGNMENT		APPLICATION NUMBER 11/307425	
NATURE OF CONVEYANCE:		ASSIGNMENT OF ASSIGNOR'S INTEREST			
CONVEYING PARTY DATA					
Name		Execution Date			
Tzyy-Jang Tseng		2006-01-20			
Cheng-Po Yu		2006-02-03			
RECEIVING PARTY DATA					
Name	Street Address	Internal Address	City	State/Country	Postal Code
Unimicron Technology Corp.	No. 38, Hsing Pong Rd., Kwei-San Industrial Exended Zone,		Taoyuan	TAIWAN	
CORRESPONDENCE DATA					
FAX NUMBER: 886-2-2369-7233					
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>					
When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.					
CUSTOMER NUMBER: 031561					
NAME OF PERSON SIGNING:		Belinda Lee			
DATE SIGNED:		2006-02-05			
Total Attachments: 2 source=17148Assignment1.tif source=17148Assignment2.tif					

OP \$40.00 11307425

ASSIGNMENT

WHEREAS,

1. Tzyy-Jang Tseng

2. Cheng-Po Yu

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **METHOD OF FORMING SOLDER MASK AND WIRING BOARD WITH SOLDER MASK**

Filed: Serial No.

Executed concurrently with the execution of this instrument

WHEREAS, Unimicron Technology Corp.

of No. 38, Hsing Pong Rd., Kwei-San Industrial Exended Zone, Taoyuan, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Tzyy-Yang Tseng Date: 01/20/06
Sole or First Joint Inventor: Tzyy-Yang Tseng

Signature: Cheng-Po Yu Date: Feb. 03, 2006
Second Joint Inventor (if any): Cheng-Po Yu